**TENTATIVE** 

TOSHIBA TRANSISTOR SILICON NPN EPITAXIAL PLANAR TYPE

# HN3C10FT

VHF~UHF BAND LOW NOISE AMPLIFIER APPLICATIONS

TWO devices are built in to the super-thin and ultra super mini (6 pins) package: TU6

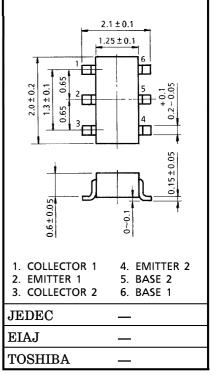
## **MOUNTED DEVICES**

	Q1/Q2
Three-pins (SSM) mold products are	2SC5086
corresponded	

## MAXIMUM RATINGS (Ta = 25°C)

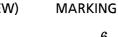
CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Base Voltage	$v_{CBO}$	20	V
Collector-Emitter Voltage	$v_{CEO}$	12	V
Emitter-Base Voltage	$v_{\mathrm{EBO}}$	3	V
Collector Current	$I_{\mathbf{C}}$	80	mA
Base Current	$I_{\mathbf{B}}$	40	mA
Collector Power Dissipation	PC	200	mW
Junction Temperature	$T_{j}$	125	°C
Storage Temperature Range	$ m T_{stg}$	-55~125	°C

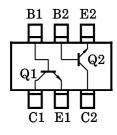
Unit in mm

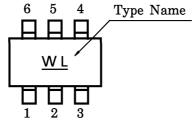


Weight: 0.008 g

# PIN ASSIGNMENT (TOP VIEW)







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# ELECTRICAL CHARACTERISTICS (Q1, Q2) (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Collector Cut-off Current	$I_{CBO}$	$V_{CB} = 10 \text{ V}, I_{E} = 0$	_	_	1	$\mu$ A
Emitter Cut-off Current	$I_{ m EBO}$	$V_{EB} = 1 V, I_{C} = 0$	_	_	1	$\mu$ A
DC Current Gain	${ m h_{FE}}$	$V_{ m CE} = 10   m V,  I_{ m C} = 20   m mA$	80	_	240	_
Transition Frequency	$\mathbf{f_{T}}$	$V_{CE} = 10 \text{ V}, I_{C} = 20 \text{ mA}$	5	7	_	GHz
Insertion Coin	$ S_{21e} ^2 Q1$	$V_{CE} = 10 \text{ V}, I_{C} = 20 \text{ mA},$	8.5	12	_	dB
Insertion Gain	$ S_{21e} ^2$ Q2	f = 1000 MHz	8	11.5		dB
Noise Figure	NF	$V_{CE} = 10 \text{ V}, I_{C} = 5 \text{ mA}, $ f = 1000 MHz	_	1.1	2	dB
Reverse Transfer	C <sub>re</sub> Q1	$V_{CB} = 10 \text{ V}, I_{E} = 0,$	_	0.7	1.2	~ F
Capacitance	C <sub>re</sub> Q2	f = 1  MHz (Note)	_	0.65	1.15	pF

(Note) :  $C_{re}$  is measured by 3 terminal method capacitance bridge.

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